Panasonic

Panasonic Semiconductor Singapore
A Division of Panasonic Semiconductor Asia Pte Ltd

Company Registration No. 197803125E 22, Ang Mo Kio Industrial Park 2, Singapore 569506. Tel: (65)64818811 Fax: (65)64816486

DOCUMENT COVER PAGE

APPROVED

Note: This cover page establishes the Doc No., Title and current status of the anached Socularent.

Doc No.	SDSC-PSE-AN17808B	Issue Level	Rev	Eff Date
DOC NO.	3D30-1 3L-AN17000B	1	4	28-MAR-05
Doc Title	Product Specifications for AN17808B	Total no. of pag (excluding this		14

Revision History

Issue	Rev	Eff Date	S/N	Page	Change Details	Remarks
1	2	4-NOV-04	1	-	Added this cover page.	
			2	7A	Added this page for leadfree specification.	
	3	15-DEC-04	1	7	Removed this page.	
			2	7A	Amended Outer Lead Surface Process &	
					Chip Mounting Method.	

	4	28-MAR-05	1	6	Removed physical product marking indications.	
					. ,	
***************************************		***************************************				

Prepared	Gus
Checked	Kennethaw
Approved	2 Eguli

Product Specifications AN17808B



	DOCUMENT
Structure	Silicon Monolithic Bipolar IC
Appearance	SIL-12 Pins Plastic Package (Power-type with Fin)
Application	Low Frequency Amplifier
Function	Dual 5W Audio Power Amplifier, with muting circuit and incorporating protection circuits

A	Absolute Maximum Ratings						
No.	o. Item Symbol Ratings		Ratings	Unit	Note		
je zazask	Storage Temperature	Tstg	-55 ~ +150	°C	\$1		
2	Operating Ambient Temperature	Topr	-25 ~ +75	°C	1		
3	Operating Ambient Pressure	Popr	$1.013 \times 10^5 \pm 0.61 \times 10^5$	Pa			
4	Operating Constant Acceleration	Gopr	9,810	m/s²			
5	Operating Shock	Sopr	4,900	m/s²			
6	Supply Voltage	Vcc	26.0	V			
	Supply Current	Icc	4.0	A			
8	Power Dissipation	$P_{\mathbf{D}}$	37.5	W	2		

i		***	§
	Operating Supply Voltage	Vec	10.037 24.037
	Operating Supply Voltage	V CC	10.0 V ~ 24.0 V

Note 1) The temperature of all item shall be Ta = 25°C except storage temperature and operating ambient temperature.

2) $Ta = 75^{\circ}C$

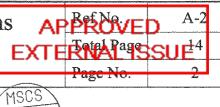
Eff. Date	Eff. Date	Eff. Date	Eff. Date	
22-OCT-03	21-NOV-03			L

2 1 NOV 2003

Prepared	Caro
Checked	lemethlaw
Approved	Higulia

Product Specifications

AN17808B



21, 11, 03

A	Absolute Maximum Ratings							
No.	Item	Symbol	Ratings	Unit	Note			
personal distribution of the second s	Pin Voltage (2-Pin)	V2	-0.3 ~ +3.0	V	, processing,			
2	Pin Voltage (5-Pin)	V5	-0.3 ~+3.0	V	1			

Note: 1) Do not apply a current or voltage from the external to the terminals not described above. For circuit current, '+' denotes the current flowing into IC and, '-' denotes the current flowing out of IC.

Eff. Date	Eff. Date	Eff. Date	Eff. Date
22-OCT-03	21-NOV-03		

Prepared Checked Approved Product Specifications AN17808B

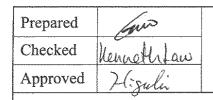
B-1

21, 11, 03

В	Vcc=19V, RL=8 Ω and f=1kHz)								
No.	Item	Symbol	Test Cir- cuit	Condition	Min	Limit Typ	Max	Unit	Note
1	Quiescent Current	Icq	permed	Vin=0mV		35	70	mA	
2	Output End Noise Voltage	Vno	Winnesd	No Input Rg=10kΩ	dnt	0.22	0.4	mV	1
3	Voltage Gain	Gv	 	Vin=57mV	32	34	36	dВ	
4	Total Harmonic Distortion	THD		Vin=57mV	****	0.2	0.4	%	The state of the s
5	Maximum Output Power 1	Po1	paramete	Vcc=19V THD=10%	4.0	5.0	100	W	
6	Maximum Output Power 2	Po2	ę mosonę	Vcc=22V THD=10%	5.6	7.0	**	W	
7	Ripple Rejection Ratio	RR	- jaconses	Vr=1Vrms, fr=120Hz, Rg=10kΩ	45	55	100-	dВ	режения
8	Channel Balance	CB	(Decord)	Vin=57mV	-1.0	0	1.0	dВ	
9	Muting Ratio	MR	- Janonsey	Vin=57mV Vmute ≥ 3.0V	65	75		dВ	
10	Muting Control Voltage	Vmute	Yosank	Vin = 57mV, MR ≥ 65dB	3.0	AND THE PROPERTY OF THE PROPER	264	V	
bosonii jaconii	Standby On Voltage	Vstb-on	process	No Input Icc < 0.1mA	494	50	0.4	V	
12	Standby Off Voltage	Vstb-off	4	No Input Icc ≥ 17mA	3,0	700		V	
13	Channel Crosstalk	СТ	- American A	Vin = 57mV Rg=10kΩ	50	60	79	dB	**************************************

Note 1) For this measurement, use the 20Hz~20kHz (12dB/OCT) filter.

Eff. Date	Eff. Date	Eff. Date	Eff. Date
22-OCT-03	21-NOV-03		

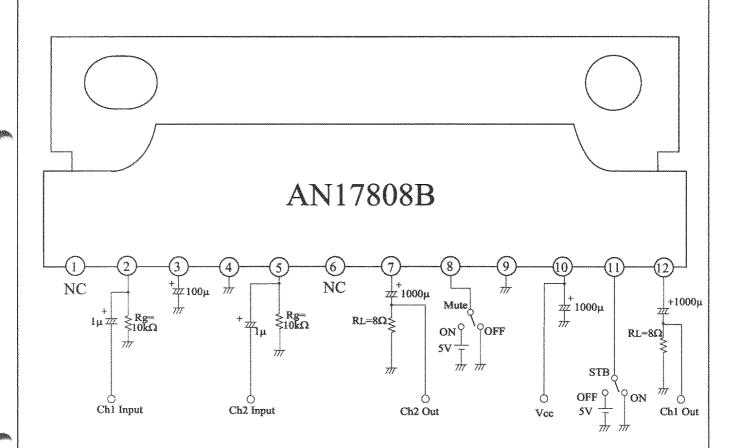


Product Specifications
AN17808B

APPROVED C-1
EXTERNIA Bage Sout 4
Page No. 4

(Description of Test Circuit and Test Method)
Test Circuit 1

MSCS 21,11,103 DOCUMENT CONTROL



Note: For STB 'OFF', connect to 5V. Mute 'OFF' means 0V.

Eff. Date	Eff. Date	Eff. Date	Eff. Date
22-OCT-03	21-NOV-03		

Prepared Gus
Checked Venueth fau
Approved Highlin

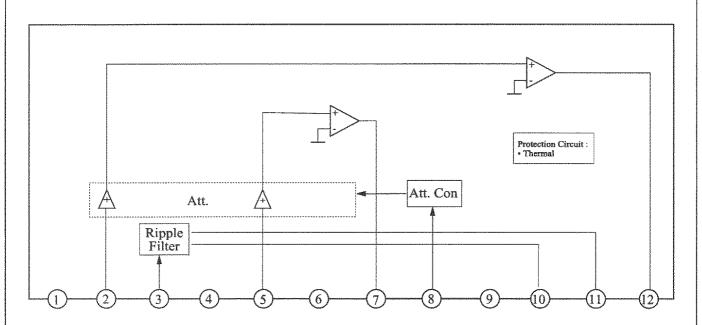
Product Specifications

AN17808B



Circuit Function Block Diagram





Pin Descriptions

Pin No.	Pin Name	Pin No.	Pin Name
1	N.C	7	Channel 2 Output
2	Channel 1 Input	8	Mute
3	Ripple Filter	9	Output GND
4	Input GND	10	Vec
5	Channel 2 Input	11	Standby
6	N.C	12	Channel 1 Output

Eff. Date	Eff. Date	Eff. Date	Eff. Date
22-OCT-03	21-NOV-03		

Prepared Lim Fuey Sheen Checked Kenneth Law Approved Yasuo Higuchi

Product Specifications

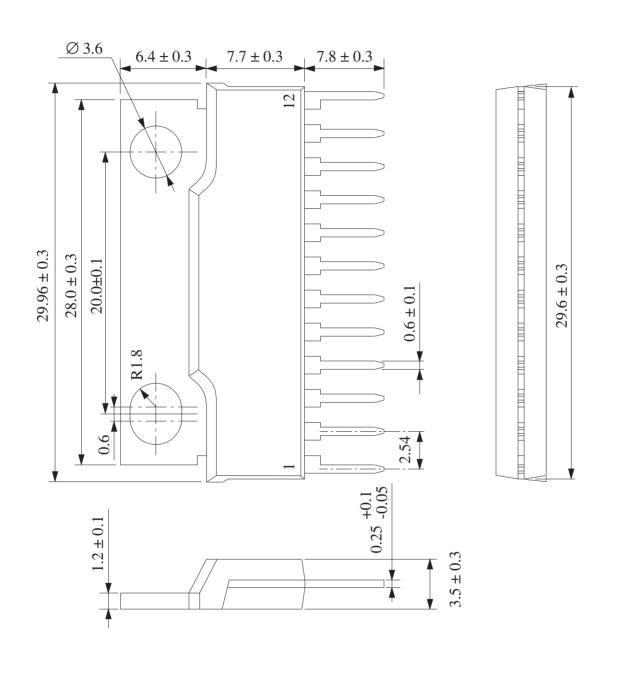
AN17808B



12-SIL(FP)

Package Name FP-12S

Unit: mm

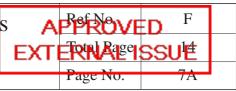


*4

Eff. Date	Eff. Date	Eff. Date	Eff. Date
28-MAR-05			

Prepared	Lim Fuey Sheen
Checked	Kenneth Law
Approved	Yasuo Higuchi

Product Specifications (Leadfree) AN17808B



(Structure Description)

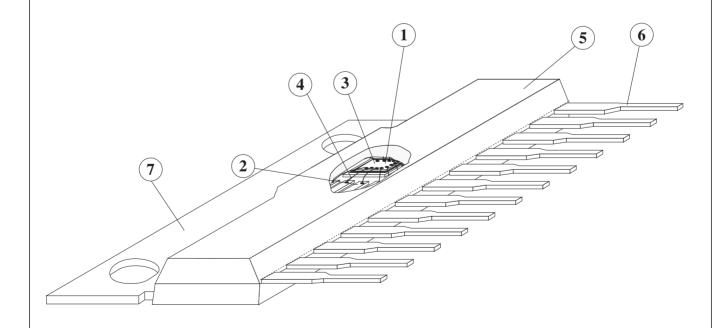
Chip surface passivation	SiN,	PSG,	Others ()	1
Lead frame material	Fe group,	Cu group,	Others ()	2,6
Inner lead surface process	Ag plating,	Au plating,	Others ()	2
Outer lead surface process	Solder plating	g (98Sn-2Bi), Solder dip,	Others ()	6
Chip mounting method	Ag paste,	Au-Si alloy, Solder (95	.5Pb-2.5Ag-2Sn)**	3
Wire bonding method	Thermalsonic	e bonding,	Others ()	4
Wire material	Au,		Others ()	4
Mold material	Epoxy,		Others ()	5
Molding method	Transfer mole	d, Multiplunger mold,	Others ()	5
Fin material	Cu group,		Others ()	7

Package FP-12S

*3

*3

**Under RoHS exemption clause, Lead (Pb) in high melting temperature type solder (i.e. tin-lead solder alloys containing more than 85% of lead), is exempted until 2010.



*3

Eff. Date	Eff. Date	Eff. Date	Eff. Date
-	-	4-NOV-04	15-DEC-04

Prepared Checked Approved

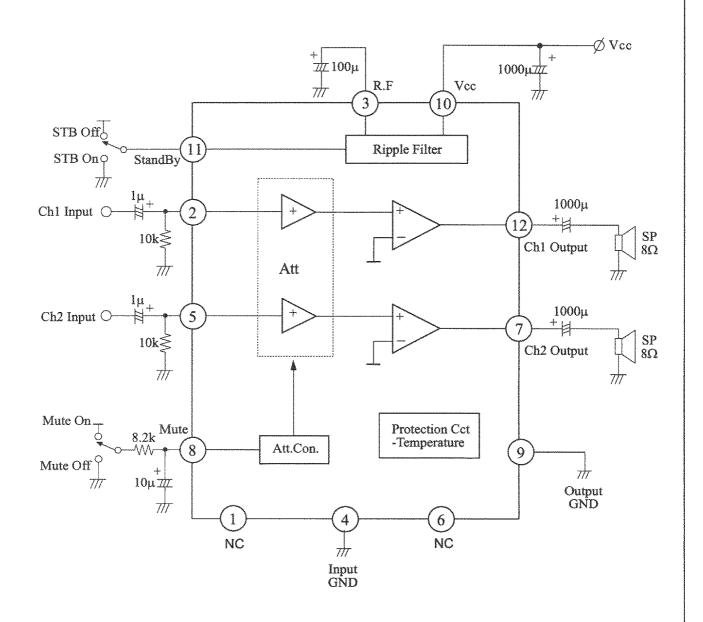
Product Specifications
(Technical Data)
AN17808B

G-1Page No.

Application Circuit 1

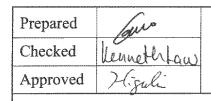
Standby Pin is controlled by microcontroller.





STB 'OFF'	5V
STB 'ON'	0V
Mute 'OFF'	0V
Mute 'ON'	5V

Eff. Date	Eff. Date	Eff. Date	Eff. Date
22-OCT-03	21-NOV-03		



Product Specifications
(Technical Data)
AN17808B

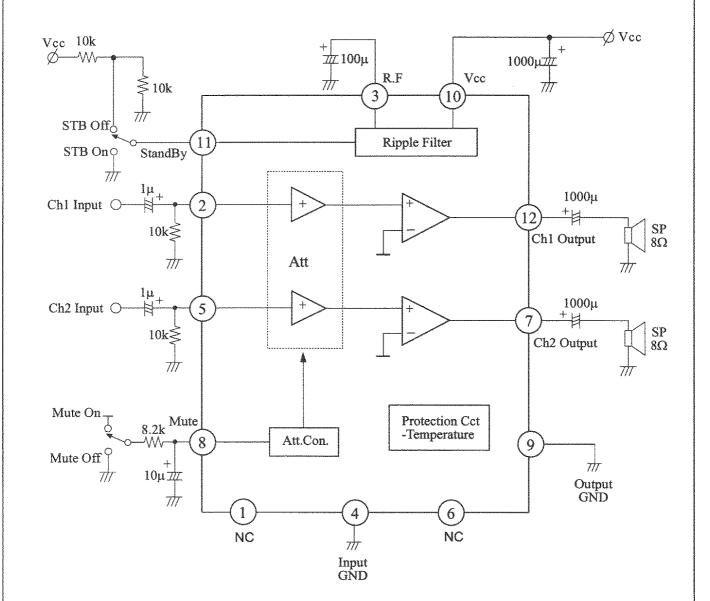
21.11.03

DOCUMENT



Application Circuit 2

Standby Pin is controlled by Vcc.



Mute 'OFF'	0V
Mute 'ON'	5V

Eff. Date	Eff. Date	Eff. Date	Eff. Date
22-OCT-03	21-NOV-03		

Prepared	Gur
Checked	Kennethlaw
Approved	Hzuli

Product Specifications
(Technical Data)

AN17808B

G-2

21.11.03 DOCUMENT

Pin No.	Function	Adjacent Circuitry	Description	DC Bias (V)
2, 5	Ch1, Ch2 Input	5 2 200 400 30k	This is the amplifier input pin.	0V
3	Ripple Filter	30k 3 20k 15k	This is the pin to connect the positive terminal of a ripple filter capacitor.	Vcc-1.5VBE
4	Input GND		Input ground pin.	0V
1,6	Not Connected			

Eff. Date	Eff. Date	Eff. Date	Eff. Date	
22-OCT-03	21-NOV-03	TOTAL AND THE PROPERTY OF THE		

-	Prepared	aio
***************************************	Checked	Kennethlaw
and the second second	Approved	Hisali

Product Specifications
(Technical Data)

AN17808B

APPROVED G-2
EXTERNALSISSUE
Page No. 11

MSCS

21.11.03

DOCUMENT
CONTROL

Pin No.	Function	Adjacent Circuitry	Description	DC Bias (V)
12,	Ch1 and Ch2 Output	Pre Amp Driver Cct 7 12 600 Vcc/2	Ch1 and Ch2 output pin	Vcc/2
8	Mute	3k 3k 3k 4	Mute input pin. Mute 'On' = 5V Mute 'Off' = 0V	
9	Output GND		Ch1 and Ch2 output ground.	0V
10	Vcc		This is the power supply pin.	Typ: 19V

Eff. Date	Eff. Date	Eff. Date	Eff. Date
			AL

Prepared Juso
Checked lemnethlaw
Approved Highlia

Product Specifications
(Technical Data)

AN17808B

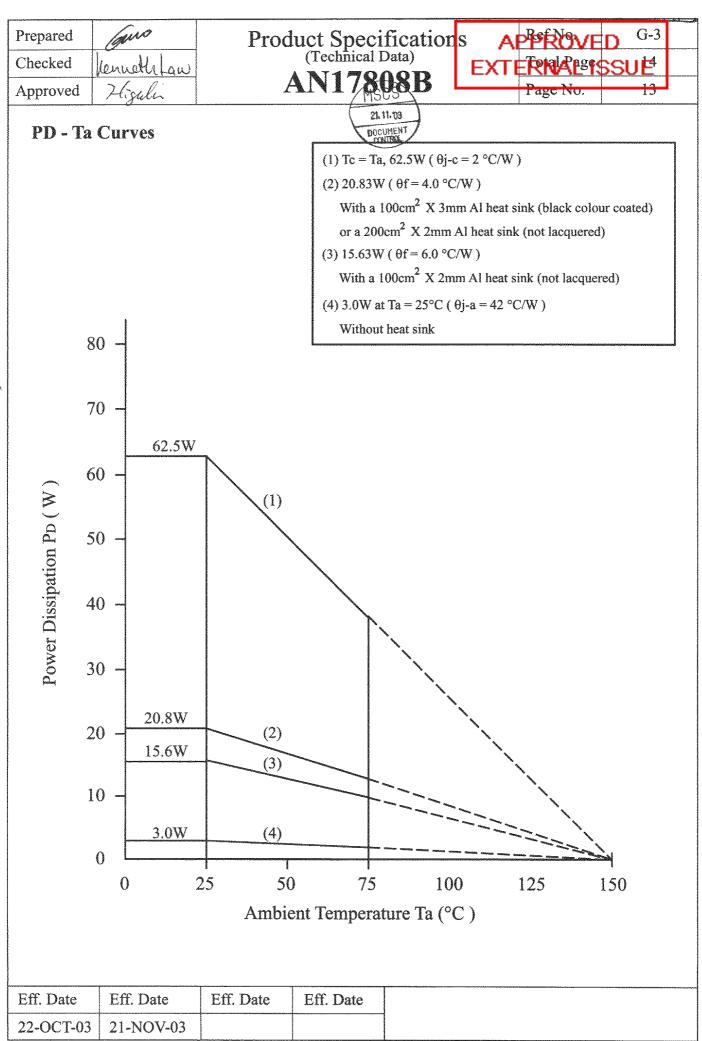
MSCS

APPROVED G-2
EXTERNALISTSSUE
Page No. 12

21.11.03 DOCUMENT

Pin No.	Function	Adjacent Circuitry	Description	DC Bias (V)
11	Standby	10k 3k	This is the Standby control pin.	

Eff. Date	Eff. Date	Eff. Date	Eff. Date
22-OCT-03	21-NOV-03		



Prepared	Gus
Checked	honneth fau
Approved	Higuli

Product Specifications

AN17808B

APPROVED H
EXTERNALSISSUE
Page No. 14



Application's Precautions

- (1) External heatsink is needed when used. External heatsink should be fixed to the chassis.
- (2) Fin of the IC can be connected to GND.
- (3) Please prevent "Output to Vcc short", "Output to GND short", "Pin shift" and "Load short". The IC may be damaged if any of these occurs and smoke may be observed.
- (4) The temperature protection circuit will operate at Tj around 150°C. However, if temperature decrease, the protection circuit will automatically be deactivated and resume normal operation.
- (5) The Absolute Maximum Supply Voltage for this IC is specified as 26V. The IC is permitted to operate up to this voltage, without causing damage, for the condition that no signal is applied to all the 2 input pins.
- (6) For the condition of chip junction temperature below the minimum thermal shutdown temperature, under continuous operation, this will not cause damage to the IC for the recommended application. The minimum thermal shutdown temperature of this IC is typically 140 °C. This value is provided as a design reference and is not guaranteed by testing.

Eff. Date	Eff. Date	Eff. Date	Eff. Date
22-OCT-03	21-NOV-03		